## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Gian Pietro Vanalli	04/29/2009
Giovanni Campardo	04/29/2009
Aldo Losavio	04/29/2009
Paolo Pulici	04/27/2009
Pier Paolo Stoppino	04/29/2009

#### RECEIVING PARTY DATA

Name:	STMicroelectronics S.r.l.
Street Address:	Via C. Olivetti 2
City:	Agrate Brianza (MI)
State/Country:	ITALY
Postal Code:	20041

Name:	Politecnico Di Milano	
Street Address:	Area Ricerca e Trasferimento Tecnologico, Technology transfers Office, Piazza Leonardo da Vinci, 32	
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## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12537075

#### **CORRESPONDENCE DATA**

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PATENT

REEL: 023067 FRAME: 0681

OF \$40.00 1253/0/5

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Correspondent Name: Wolf Greenfield & Sacks, P.C.

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ATTORNEY DOCKET NUMBER: \$1022.71353US00

NAME OF SUBMITTER: James H. Morris

Total Attachments: 2

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PATENT REEL: 023067 FRAME: 0682 Serial.No. 12/537,075 Attorney's Docket No. S1022.71353US00 Filing Date: August 6, 2009

### **ASSIGNMENT**

For good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned hereby:

Sell, assign and transfer to STMicroelectronics S.r.l., a corporation having a place of business at Via C. Olivetti 2, 20041 Agrate Brianza (MI), Italy, and Politecnico Di Milano having a place of business at Area Ricerca e Trasferimento Tecnologico, Technology transfers Office, Piazza Leonardo da Vinci, 32, 1-20133 Milan, ITALY, their successors, assigns and legal representatives, all hereinafter referred to as the Assignee, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions which are disclosed in the application for United States Letters Patent executed on even date herewith and entitled METHOD FOR FORMING BUMPS IN SUBSTRATES WITH THROUGH VIAS, and in and to said application and all divisional, continuing, substitute, renewal, reissue and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said inventions; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said inventions including the right to apply for patent rights in each foreign country and all rights to priority.

Agree that said Assignee may apply for and receive Letters Patent for said inventions in its own name; and when requested, without charge to but at the expense of said Assignee, agree to carry out in good faith the intent and purpose of this assignment by executing all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions, by executing all rightful oaths, assignments, powers of attorney and other papers, by communicating to said Assignee all facts known to me relating to said inventions and the history thereof, and generally by doing everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection for said inventions and for vesting title to said inventions and all applications for patents and all patents on said inventions, in said Assignee.

Hereby request the Honorable Director of Patents and Trademarks to issue said Letters Patent to said Assignee.

Covenant with said Assignee that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me, and that full right to convey the same as herein expressed is possessed by me.

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PATENT REEL: 023067 FRAME: 0683

Serial No. 12/537,075 Filing Date: August 6, 2009

The undersigned hereby grant(s) the firm of Wolf, Greenfield & Sacks, P.C., of 600 Atlantic Avenue, Boston, Massachusetts 02210 the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent office for recordation of this document.

Date: 29/4/2009

Signature Gian Pietro VANALLI

Date: 29/4/2009

Signature hoven Campado
Printed Name: Giovanni CAMPARDO

Date: <u>19/4/2009</u>

Signature Aldo LOSAVIO

Date: 04 27 2003

Signature Paolo PULICI

Date: 04 / 25 / 2005

Signature Printed Name: Pier Paolo STOPPINO